

PRIMERGY RX300 S6

System configurator and order-information guide

July 2012

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Change report







PRIMERGY Server

Instructions

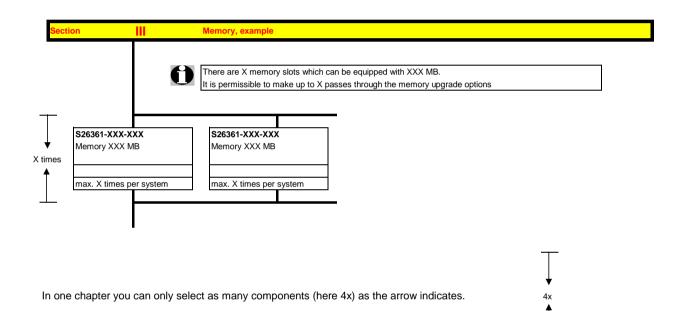
This document contains basic product and configuration information that will enable you to configure your system via PC-/System-Architect.

Only these tools will ensure a fast and proper configuration of your PRIMERGY server or your complete PRIMERGY Rack system.

You can configure your individual PRIMERGY server in order to adjust your specific requirements.

The System configurator is divided into several chapters that are identical to the current price list and PC-/SystemArchitect.

Please follow the lines. If there is a junction, you can choose which way or component you would like to take. Go through the configurator by following the lines from the top to the bottom.



Please note that there are information symbols which indicate necessary information.



For further information see:

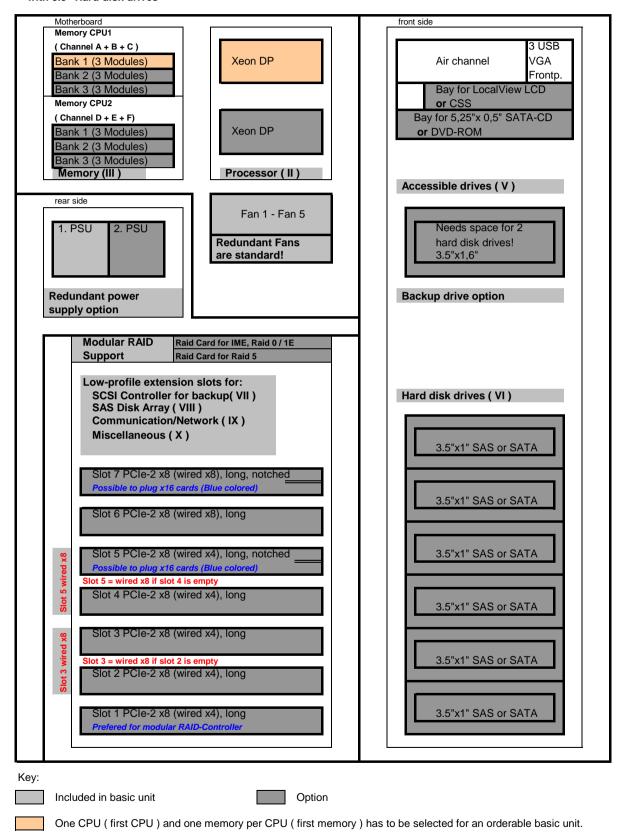
http://ts.fujitsu.com/products/standard_servers/inc (internet)

https://partners.ts.fujitsu.com/com/order-supply/configurators/primergy_config/current/Pages/default.aspx (extranet)

Configuration diagram PRIMERGY RX300 S6

System unit (I)

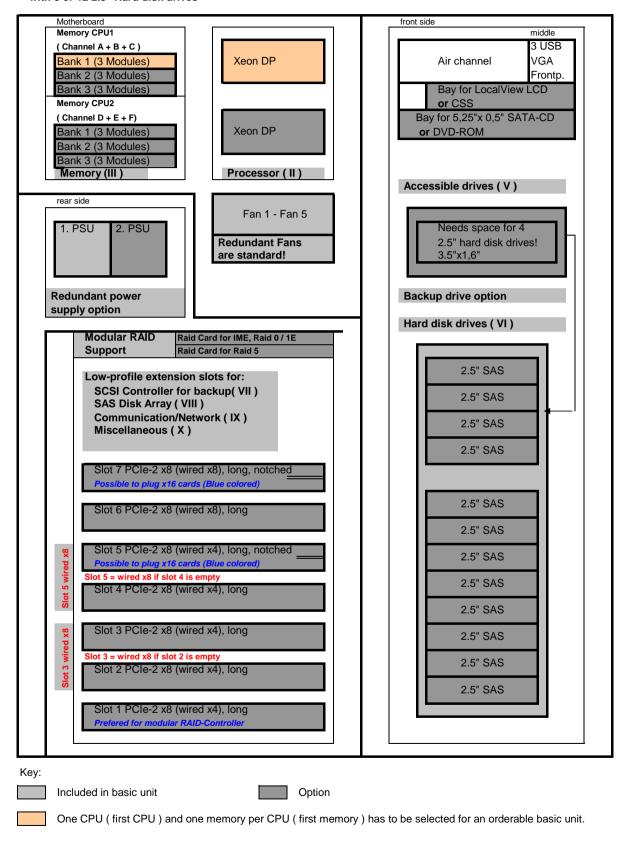
with 3.5" Hard disk drives

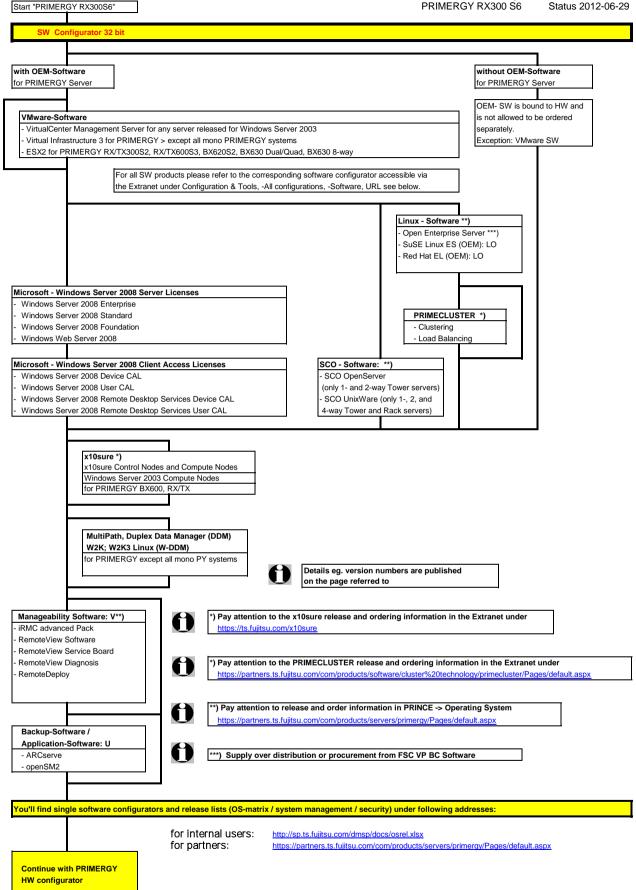


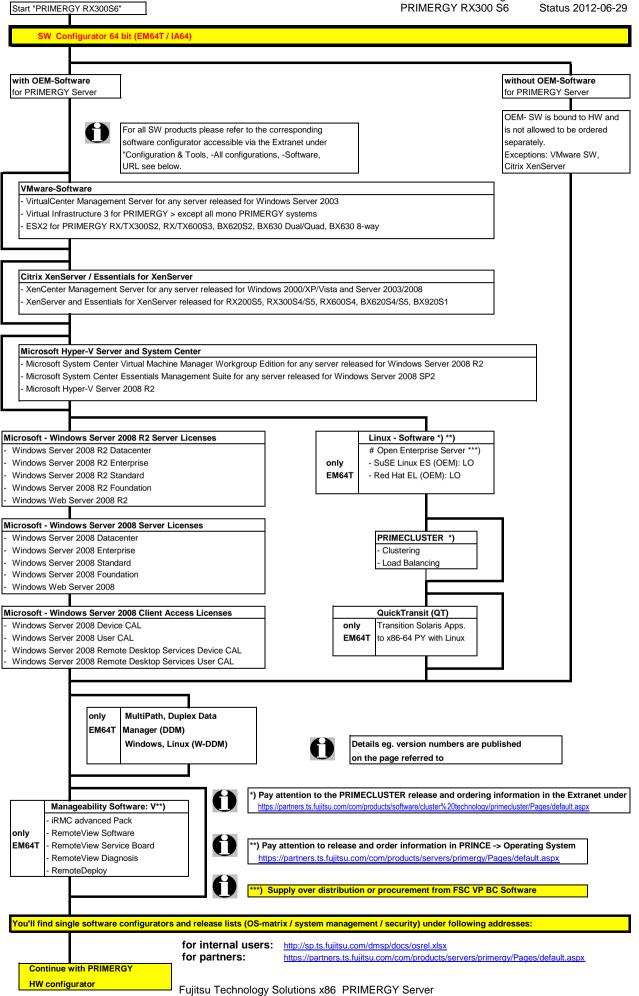
Configuration diagram PRIMERGY RX300 S6

System unit (1)

with 8 or 12 2.5" Hard disk drives







Section

Basic unit

System unit consisting of:

- * 2U Housing including one power supply module
 - hot plug Power supply unit with 1 PSU module and power cord rack 4m lenght (can be upgraded with one additional PSU module)
- * Fan unit with 5 hot plug system-fans redundant
- * SAS Backplane for 6x 3.5" HD or SAS Backplane for 8 or 12x 2.5" HD
 - with cable connection to modular RAID Controller
 - -> 3 different basic units for 6x 3.5" HD or 8 or 12x 2.5" HD
- * 9 memory DIMMs per CPU (max 192GB) => Total 18 DIMMs (max 384GB) for two CPU's * Drives/Bays
 - 6 bays 1" for hot plug 3.5" HD (1" high) or 8 or 12 bays for hot plug 2.5" HD
 - 1 bay for 3.5" and 1.6" high Backup device, consumes 2 bays for 3.5" HD for basic unit 6x 3.5" HD not possible for basic unit with 12x 2,5" HD
 - 1 bay SATA-CD- or DVD-ROM 0,5" height (option)
 - 1 bay for opt. CSS-Display or LocalView LC-Display
- * Integrated ServerView Diagnostics Technology (Diagnosis LED's) for indication of internal failed components

Systemboard D2619 with:

- * Up to two Xeon Dual/Quad/Six-Core or Turbo Quad/Six Core CPU's (Westmere-EP, LGA 1366 socket) with serial QPI links (Quick Path Interconnect) and three memory channels per CPU First CPU has to be selected for an orderable basic unit.
- * Chipset Intel® 5520P (codenamed Tylersburg-EP or 36D)
- * 7 PCI slots: 2x PCIe-2 x8 (wired x8, notched, possible to plug x16 card)
 - 5x PCIe-2 x8 (wired x4)

From 4 PCle-slots each two wired x4 slots can be combined to one wired x8 slot

- * 18 memory slots for max. 384GB (12x32GB) RAM DDR3 available
- Memory is divided into 9 DIMMs per CPU (3 channels with 3 slots per channel)
- Max. 3x reg 1.5V or 2x reg. 1.35V quad ranked / unbuffered modules are possible per channel First Memory (one module) has to be selected for an orderable basic unit per CPU
- Memory upgrade is possible module wise
- Memory mirrroring is supported with 2 identical modules in channel A+B CPU 1 or D+E CPU 2
- Hot Spare Memory is supported with 3 identical modules in channel A+B+C CPU 1 or D+E+F CPU 2
- SDDC (Chipkill) is supported for memory modules,
- * Dual Port 10/100/1000 x4 PCI Express* Gigabit Ethernet Intel LAN controller Zoar on-board
- * iRMC S2 (integrated Remote Management Controller) on-board server management controller with dedicated 10/100 Service LAN-port and integrated graphics controller.

The Service LAN-port can be switched alternatively on standard Gbit LAN port 1

Graphics Controller integrated in iRMC S2 (integrated Remote Management Controller): 1600x1200x16bpp 60Hz, 1280x1024x16bpp 60Hz, 1024x768x32bpp 75Hz, 800x600x32bpp 85Hz, 640x480x32bpp 85Hz

(1280x1024x24bpp 60Hz only possible if local monitor or remote video redirection is off)

Interfaces at the rear:

- * 1x RS-232-C (serial, 9 pins) (usable for BMC or OS or shared)
- * 1x RS-232-C (serial, 9 pins)
- * 1x VGA (15 pins)
- * 4x USB 2.0 (UHCI) with 480MBit/s, no USB wakeup
- * 2x LAN RJ45, 1x Service-LAN RJ45

Interfaces on the front:

- 3x USB **2.0** (UHCl) with **480MBit/s,** no USB wakeup
- * 1x VGA (15 pins) as an option

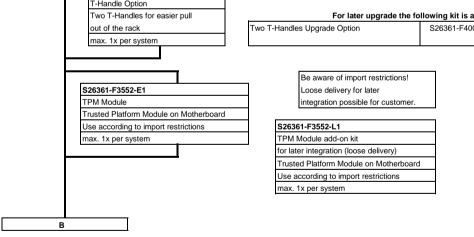
Interfaces internal:

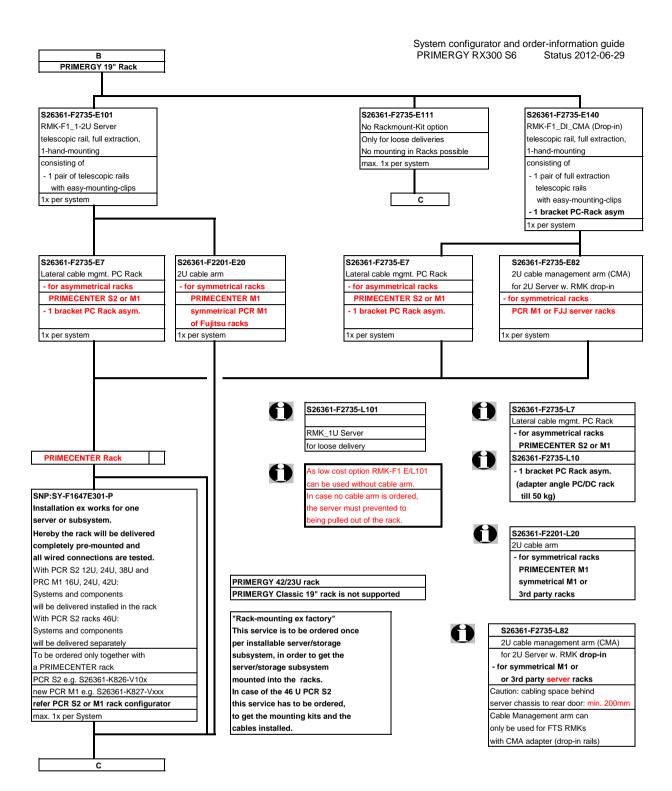
- * 1x released internal USB Interfaces for backup device,
- * 1x USB $\pmb{2.0}$ (UHCI) with $\pmb{480\text{MBit/s}}$ for dongle funcionality, no USB wakeup
- * 2x SATA for internal devices

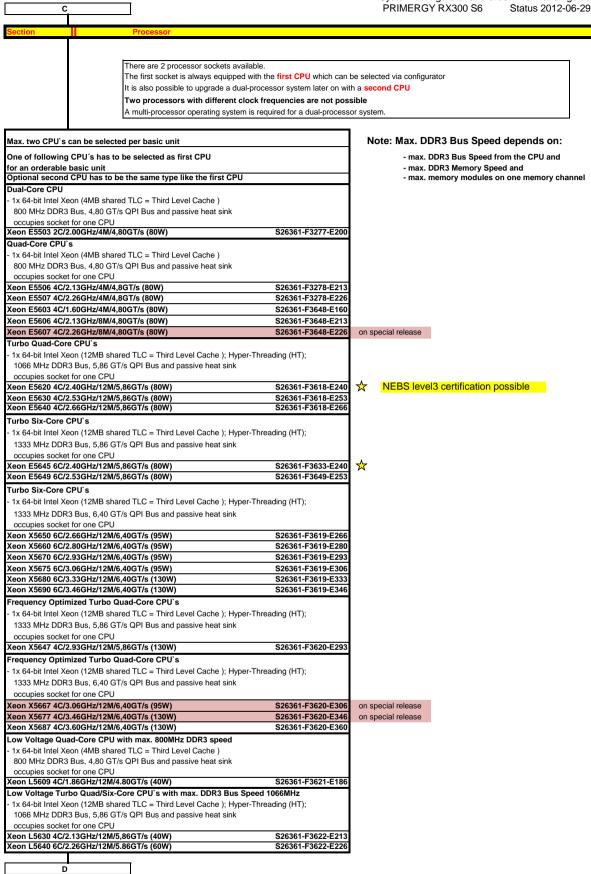
Software:

* ServerView Suite Software package incl. ServerStart, ServerBooks, Management Software and Updates
* Documentation engl. (multilingual on CD)

Α







- There are 9 memory slots per CPU for max.

72GB (9x 8GB single / dual rank 1.5V RDIMM's)

96GB (6x 16GB quad rank 1.5V RDIMMs)

12GB (6x 2GB UDIMMs)

=> max. 192GB for two CPU's (96GB per CPU)

(For explanation of following terms refer to section "Memory Configurations"

- The memory area is divided into 3 channels per CPU with 3 slots per channel
- Slot 1 of each channel belongs to memory bank 1, the slot 2 belongs to memory bank 2 and slot 3 belongs to memory bank 3

Systems with 3DPC (9 DIMMs / CPU) do not support mix of dual rank and quad rank modules

Registered and unbuffered memory modules can be selected

No mix of registered and unbuffered modules allowed.

DDR3 1066 and 1333MHz modules can be mixed, but run always with the slower speed.

With two DIMMs per channel, 1.5V DIMMs operate with 1333Mhz, 1.35V with 1066MHz as max., dep. on CPU

If 1.5V DIMMs and 1.35V (Low Voltage) DIMMs are mixed, DIMMs will run at 1.5V SDDC (Chipkill) is supported only for registered memory modules.

1.) In the "Independent Channel Mode" is following configuration possible

Each slot can optionally be equipped either with registered x4 organized DDR3 modules: 2GB single rank, 4GB and 8GB dual rank, 16GB quad rank or with unbuffered x8 organized DDR3 modules: 2GB dual rank

2.) In the "Spare Channel Mode" is following configuration possible

- Each memory bank can optionally be equipped with 3x2GB single rank,

3x4GB and 3x8GB dual rank or 3x 16GB quad rank DDR3 modules.

Each slot of one bank has to be equipped with identical modules for spare channel mode

In channel A and B of CPU 1 or channel D and E of CPU 2 are always the active memory modules,

in channel C of CPU 1 and channel F of CPU 2 is always the spare module

No special order codes with UDIMMs are offered for this mode

3.) In the "Mirrored Channel Mode" is following configuration possible

Each memory bank can optionally be equipped with 2x2GB single rank.

2x4GB and 2x8GB dual rank or 2x16GB quad rank DDR3 modules.

In each memory bank channel A and B of CPU 1 or channel D and E of CPU 2 have to be equipped with

identical modules for mirrored channel mode. Channel C of CPU 1 and channel F of CPU 2 is not equipped

In channel B is always the mirrored memory of channel A of CPU 1 In channel E is always the mirrored memory of channel D of CPU 2

No special order codes with UDIMMs are offered for this mode

For each CPU minimum 1 memory module has to be configured in Independent Channel Mode

(=> Additional memory extensions can still be configured up to eight times per CPU) or

one bank has to be equipped with two modules (channel A+B for CPU 1 or D+E for CPU 2) in

Mirrored Channel Mode

(=> Additional memory extensions can still be configured up to two times per CPU) or

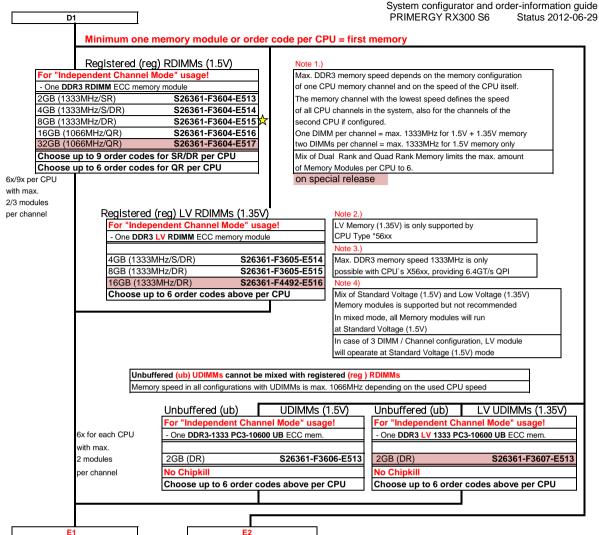
one bank has to be equipped with three modules (channel A+B+C for CPU 1 or D+E+F for CPU 2)

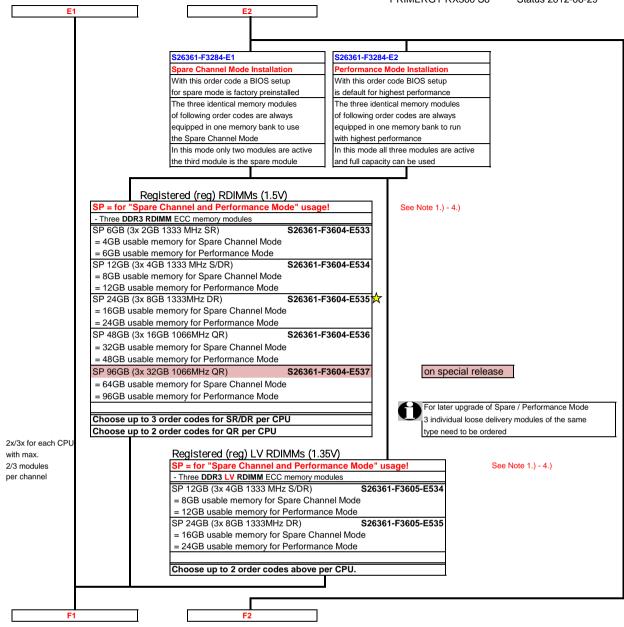
in Spare Channel Mode or Performance Mode

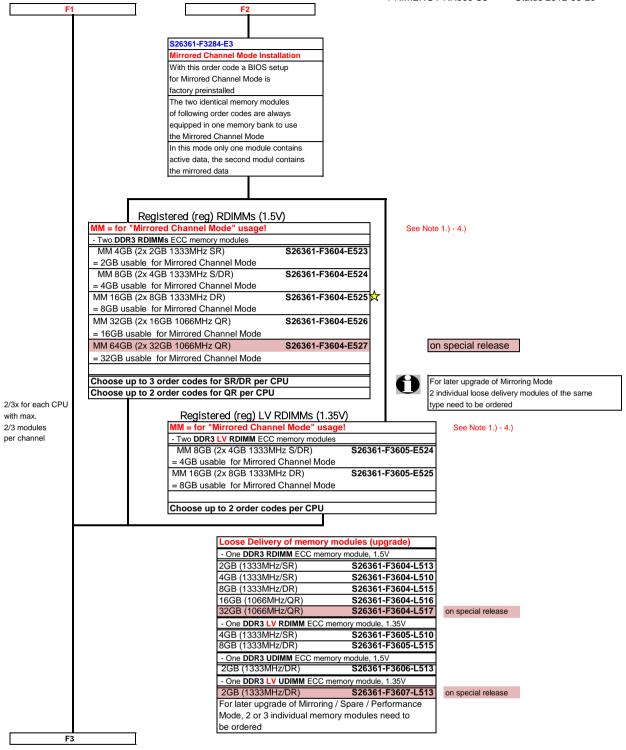
(=> Additional memory extensions can still be configured up to two times per CPU)

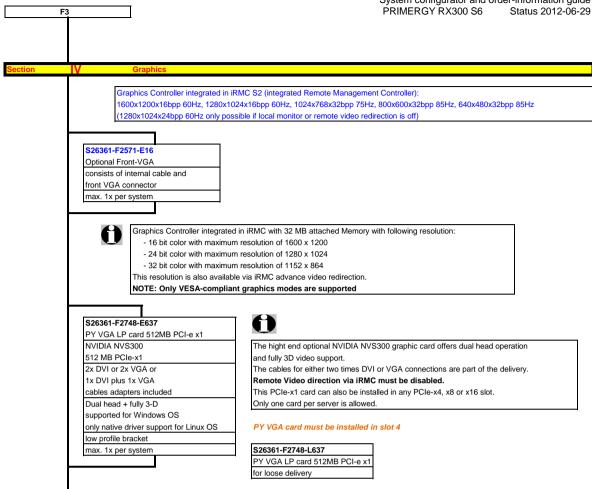
D1

For a description of memory configurations refer to section "Memory Configurations"









Memory Configuration PRIMERGY RX300 S6

Each CPU offers 9 Slots for DDR3 Memory Modules organised in 3 Banks and 3 Channels.

If you need more than 9 Slots you have to configure the 2nd CPU.

Depending on the amount of memory configured you can decide between 4 basic modes of operation (see explanation below).

There are 4 different kinds of DDR3 Memory Modules available: UDIMM / UDIMM LV and RDIMM / RDIMM LV UDIMM and RDIMM offer different functionality. Mix of UDIMM + RDIMM is not alloved.

Mixing of Standard + Low Voltage DIMM's of the same type is allowed, but not recommendet (therefore not configurable ex works) If 1.5V and 1.35V DIMMs are mixed, the DIMMs will run at 1.5V

Mixing of SR / DR and QR Memory Modules will limit the max. amount of modules per CPU to 6.

| Mode | Configuration | UDIMM | RDIMM | Application |
|-----------------------|----------------------------|-------|-------|---|
| chip kill support | any | n.a. | yes | detect multi-bit errors |
| Independant Channel | 1, 2 or 3 Modules per Bank | Х | Х | offers max. flexibility, upgradeability, capacity |
| Mode | | | | use UDIMM modules for lowest cost |
| Mirrored Channel Mode | 2 identical Modules / Bank | **) | Х | offers maximum security |
| Performance Mode *) | 3 identical Modules / Bank | **) | Х | offers maximum performance and capacity |
| Spare Channel Mode *) | 3 identical Modules / Bank | **) | Х | balances security and capacity |

^{*) =} Performance Mode and Spare mode use different BIOS settings.

x = order codes available

| Capacity | Configuration | UDIMM | RDIMM | RDIMM LV | Notes |
|------------------------|---------------------|-------|--------|----------|-----------------------------|
| Min. Memory per CPU | 1 Module / CPU | 1x2GB | 1x2GB | 1x 4GB | with one CPU |
| Max. Memory per CPU | 6/9 Modules / CPU | 6x2GB | 6x16GB | 6x 8GB | with one CPU |
| Max. Memory per System | 12 Modules / System | 24GB | 192GB | 96GB | if second CPU is configured |

Memory-Speed:

Max. DDR3 memory speed depends on the memory configuration on one memory channel and the speed of the CPU

One DIMM per channel = max. 1333MHz, two DIMMs per channel = max. 1333MHz for 1.5V / max. 1066 for 1.35V memory, three DIMMs per channel = max. 800MHz.

The memory channel with the lowest speed defines the speed of all CPU channels in the system

| DIMM Type | DIMM Slots per Channel | DIMMs populated per Channel | Memory Speed max (CPU dependent) | Ranks per DIMM | | | |
|---------------------------------|-------------------------------|-----------------------------|---|---|--|--|--|
| RDIMM 1.5V 1333Mhz | 2/3 2/3 2/3 2/3 3 | 1 1 2 2 3 | 800, 1066, 1333 800, 1066 800, 1066, 1333 800 800 | SR / DR QR Mix of SR + DR Mix of QR + SR / DR Mix of SR + DR | | | |
| RDIMM LV / 1.35V 1333Mhz | 2/3 2/3 2/3 2/3 3 | 1 1 2 2 2 3 | 800, 1066, 1333 800, 1066 800, 1066 800 800 | SR / DR QR* Mix of SR + DR Mix of QR* + SR / DR Mix of SR + DR ** | | | |
| UDIMM 1.5V 1333Mhz | 2/3 | 1 2 | 800, 1066, 1333 800, 1066, 1333 | SR / DR Mix of SR + DR | | | |
| UDIMM LV / 1.35V 1333Mhz | 2/3 | 1 2 | 800, 1066, 1333 800, 1066 | SR / DR Mix of SR + DR | | | |

 $[\]ensuremath{^{*}}$ no memory modules released for this configuration

^{**) =} technically possible but no Order Numbers available, use at your own risk

^{**} lost LV-mode, memory will switch to 1,5V Vcc automatically

| Used CPU | | | | | Memory-Bus speed depending on DIMMs / channel lowing memory speed is used for specific CPU's | | | | | | | | | | |
|--|---------------------------|----------|---------------------------------|------|--|---|------|--------------------------------|-----|------|-----------------------------------|---|------|------|---|
| | UDIMM 1333 MHz 1.5V | | UDIMM 1333 MHz LV / 1.35V | | RDIMM 1333 MHz 1.5V | | | RDIMM 1333 MHz LV /1.35V | | | RDIMM 1066 MHz (QR) 1.5V | | | | |
| Populated Dimms / Channel | 1 | 2 | 3 | 1 | 2 | 3 | 1 | 2 | 3 | 1 | 2 | 3 | 1 | 2 | 3 |
| Dual-Core CPU | | | | | | | | | | | | | | | |
| with max. 800MHz DDR3 speed (4.8GT/s) | | | | | | | | | | | | | | | |
| Xeon E5503 2C/2.00GHz/2M/4,80GT/s (80W) | 800 | 800 | - | 800 | 800 | - | 800 | 800 | 800 | 800 | 800 | - | 800 | 800 | - |
| Quad-Core CPU's | | | | | | | | | | | | | | | |
| with max. 800MHz DDR3 speed (4.8GT/s) | | | | | | | | | | | | | | | |
| Xeon E5506 4C/2.13GHz/4M/4,8GT/s (80W) | 800 | 800 | - | 800 | 800 | - | 800 | 800 | 800 | 800 | 800 | - | 800 | 800 | - |
| Xeon E5507 4C/2.26GHz/4M/4,8GT/s (80W) | 800 | 800 | - | 800 | 800 | - | 800 | 800 | 800 | 800 | 800 | - | 800 | 800 | - |
| Turbo Quad-Core CPU`s | | | | | | | | | | | | | | | |
| with max. 1066MHz DDR3 speed (5.86GT/s) | | | | | | | | | | | | | | | |
| Xeon E5620 4C/2.40GHz/12M/5,86GT/s (80W) | 1066 | 1066 | - | 1066 | 1066 | - | 1066 | 1066 | 800 | 1066 | 1066 | - | 1066 | 800 | - |
| Xeon E5630 4C/2.53GHz/12M/5,86GT/s (80W) | 1066 | 1066 | - | 1066 | 1066 | - | 1066 | 1066 | 800 | 1066 | 1066 | - | 1066 | 800 | - |
| Xeon E5640 4C/2.66GHz/12M/5,86GT/s (80W) | 1066 | 1066 | - | 1066 | 1066 | - | 1066 | 1066 | 800 | 1066 | 1066 | - | 1066 | 800 | - |
| Turbo Six-Core CPU`s | | | | | | | | | | | | | | | |
| with max. 1333MHz DDR3 speed (5.86GT/s) | | | | | | | | | | | | | | | |
| Xeon E5645 6C/2.40GHz/12M/5,86GT/s (80W) | 1333 | 1333 | - | 1333 | 1066 | - | 1333 | 1333 | 800 | 1333 | 1066 | - | 1066 | 800 | - |
| Xeon E5649 6C/2.53GHz/12M/5,86GT/s (80W) | 1333 | 1333 | - | 1333 | 1066 | - | 1333 | 1333 | 800 | 1333 | 1066 | - | 1066 | 800 | - |
| Turbo Six-Core CPU`s | | | | | | | | | | | | | | | |
| with max. 1333MHz DDR3 speed (6.4GT/s) | | | | | | | | | | | | | | | |
| Xeon X5650 6C/2.66GHz/12M/6,40GT/s (95W) | 1333 | 1333 | - | 1333 | 1066 | - | 1333 | 1333 | 800 | 1333 | 1066 | ı | 1066 | 800 | - |
| Xeon X5660 6C/2.80GHz/12M/6,40GT/s (95W) | 1333 | 1333 | - | 1333 | 1066 | - | 1333 | 1333 | 800 | 1333 | 1066 | - | 1066 | 800 | - |
| Xeon X5670 6C/2.93GHz/12M/6,40GT/s (95W) | 1333 | 1333 | - | 1333 | 1066 | - | 1333 | 1333 | 800 | 1333 | 1066 | - | 1066 | 800 | - |
| Xeon X5680 6C/3.33GHz/12M/6,40GT/s (130W) | 1333 | 1333 | - | 1333 | 1066 | - | 1333 | 1333 | 800 | 1333 | 1066 | - | 1066 | 800 | - |
| Frequency Optimized Turbo Quad-Core CPU's | | | | | | | | | | | | | | | |
| with max. 1333MHz DDR3 speed (6.4GT/s) | | | | | | | | | | | | | | | |
| Xeon X5667 4C/3.06GHz/12M/6,40GT/s (95W) | 1333 | 1333 | - | 1333 | 1066 | - | 1333 | 1333 | 800 | 1333 | 1066 | - | 1066 | 800 | - |
| Xeon X5677 4C/3.46GHz/12M/6,40GT/s (130W) | 1333 | 1333 | - | 1333 | 1066 | - | 1333 | 1333 | 800 | 1333 | 1066 | - | 1066 | 800 | - |
| Low Voltage Quad-Core CPU | | | | | | | | | | | | | | | |
| with max. 1066MHz DDR3 speed (4.8GT/s) | | | | | | | | | | | | | | | |
| Xeon L5609 4C/1.86GHz/12M/4.80GT/s (40W) | | 1066 | - | 1066 | 1066 | - | 1066 | 1066 | 800 | 1066 | 1066 | - | 1066 | 1066 | - |
| Low Voltage Turbo Quad-Core CPU | | | | | | | | | | | | | | | |
| with max. 1066/1333MHz DDR3 speed (5.86GT/s) | | <u> </u> | | | | | | | | | | | | | |
| Xeon L5630 4C/2.13GHz/12M/5,86GT/s (40W) | 1066 | 1066 | - | 1066 | 1066 | - | 1066 | 1066 | 800 | 1066 | 1066 | - | 1066 | 800 | - |
| Xeon L5640 6C/2.40GHz/12M/5.86GT/s (60W) | 1333 | 1333 | - | 1333 | 1066 | - | 1333 | 1333 | 800 | 1333 | 1066 | - | 1066 | 800 | - |

SR - Single Rank - 1Rx4 DR - Dual Rank - 2Rx4

QR - Quad Rank - 4Rx4

1DPC = 1 DIMM per Channel 2DPC = 2 DIMM per Channel 3DPC = 3 DIMM per Channel



Configuration hints:

- The memory sockets on the systemboard offer a color coding:

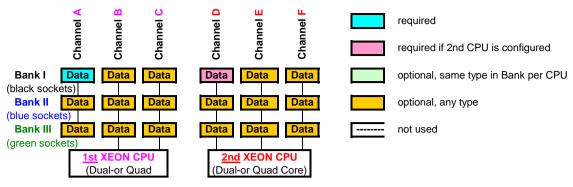
Bank II black sockets
Bank III blue sockets
Bank III green sockets

- A so called Bank consits of 1 memory module on every Channel available on one CPU (examples see below)

Bank I on CPU 1
Bank II on CPU 1
Bank III on CPU 1
Bank III on CPU 1
Bank III on CPU 2

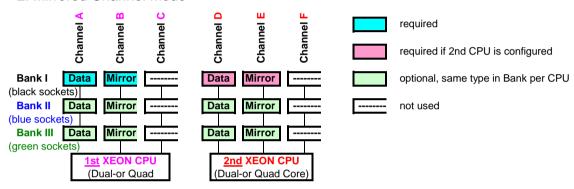
- See below and next page for a detailed descriptions of the memory configuration supported.

1. Independent Channel Mode



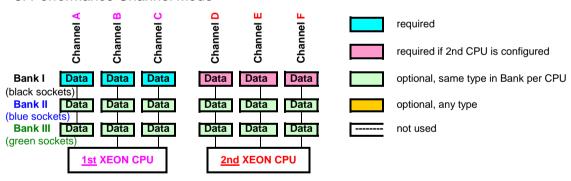
Independent Channel Mode allows all channels to be populated in any order Can run with differently rated DIMMs and use the settings of the slowest DIMM within a channel

2. Mirrored Channel Mode



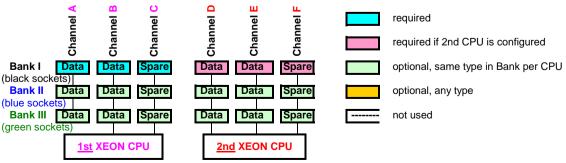
Mirrored Channel Mode requires identical modules on channel A and B (1st CPU) or channel D and E (2nd CPU) 50% of the capacity is used for the mirror => the available memory for applications is only half of the installed memory Channel C (1st CPU) or channel F (2nd CPU) are not usable in Mirrored Channel Mode

3. Performance Channel Mode

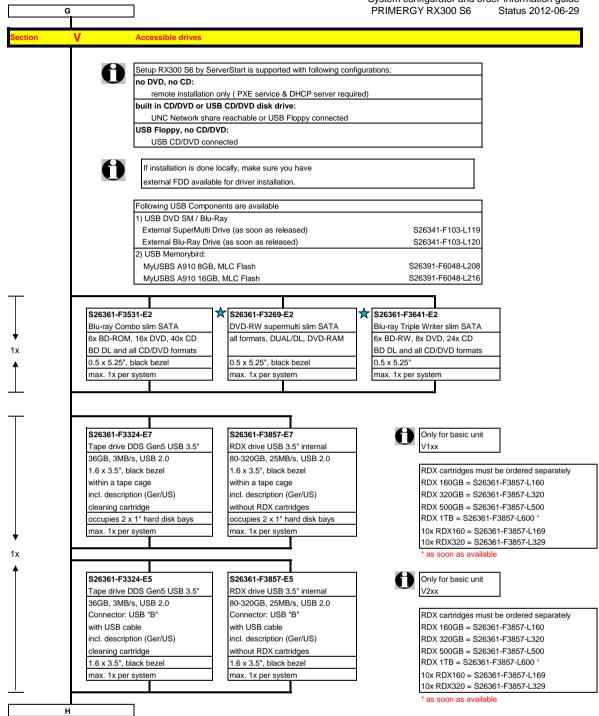


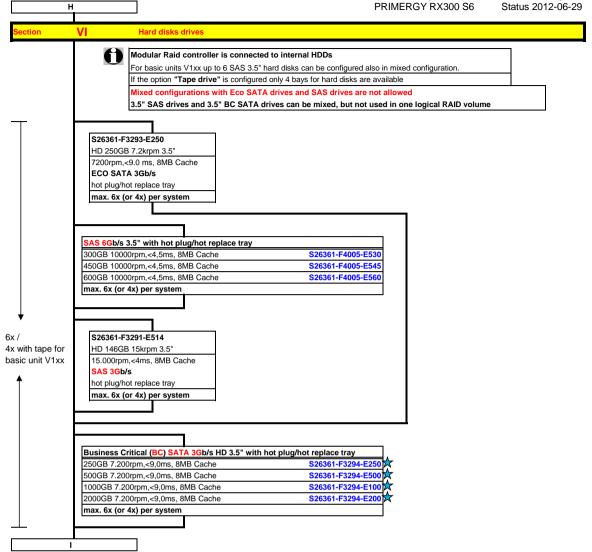
Performance Channel Mode requires identical modules on all channels of each Bank per CPU

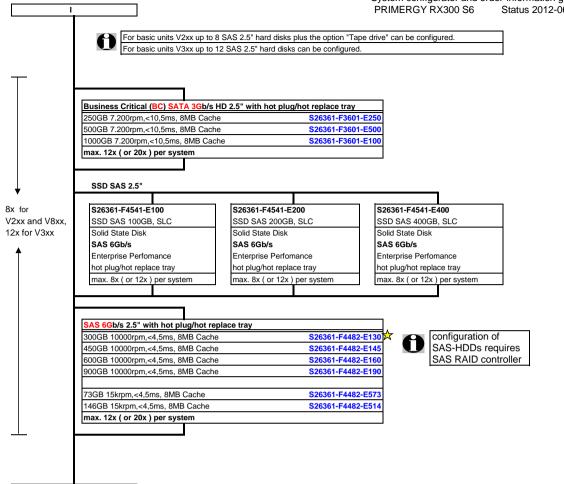
4. Spare Channel Mode

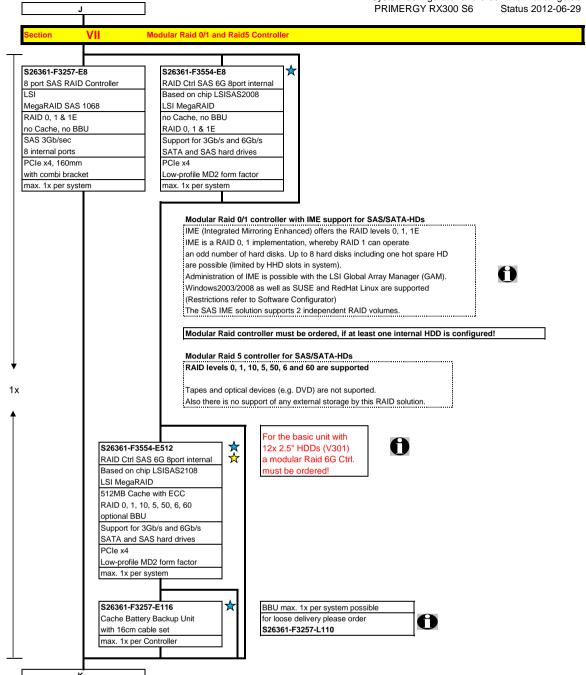


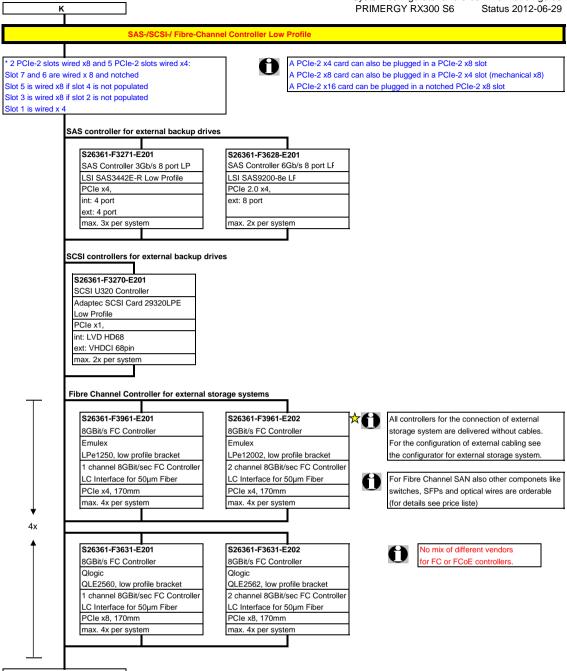
Spare Channel Mode requires identical modules on all channels of each Bank per CPU one third of the capacity is used for the spare => the available memory for applications is two thirds of the installed memory Spare Channel Mode is supported using RDIMM memory modules

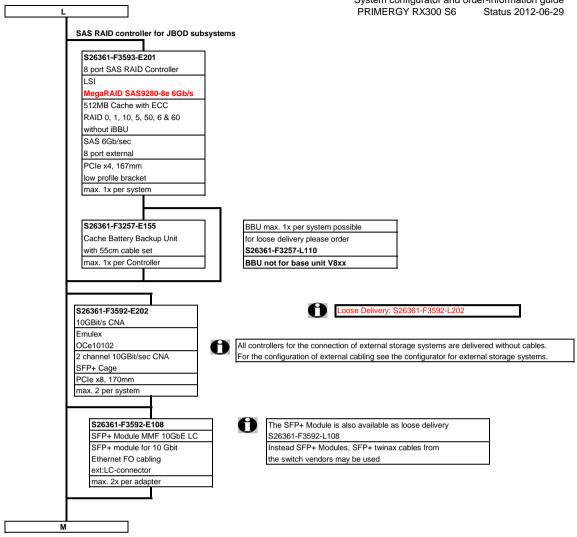


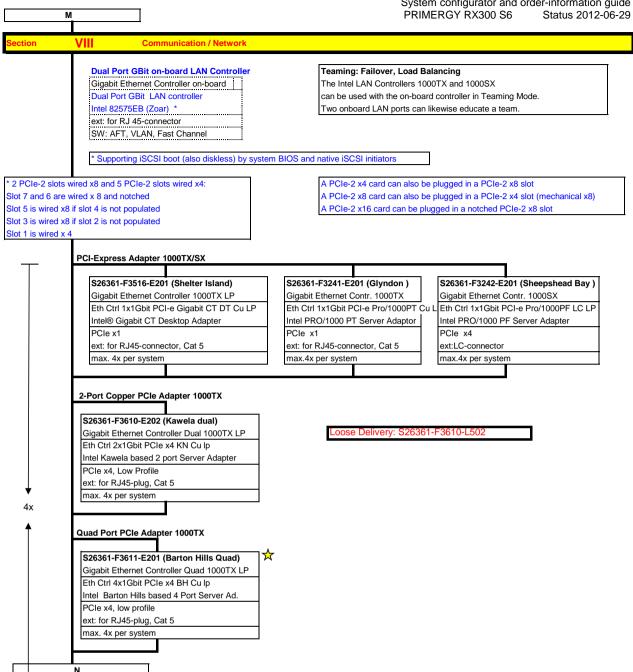




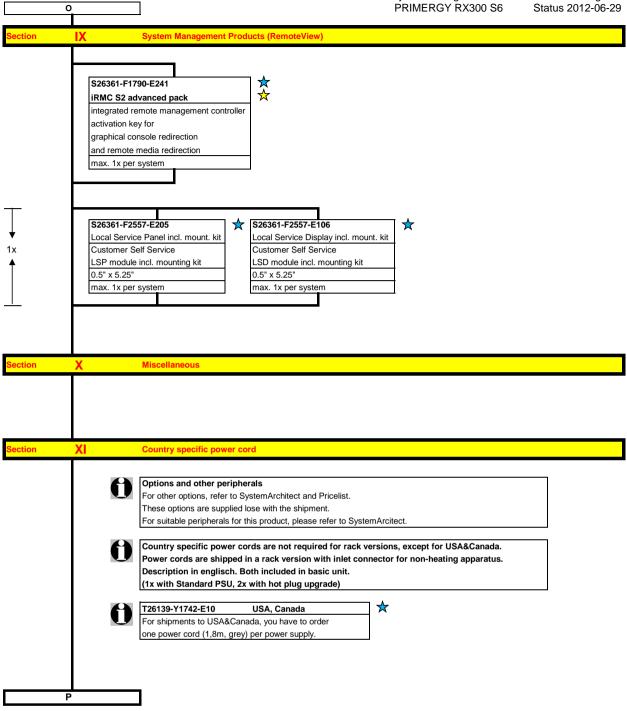


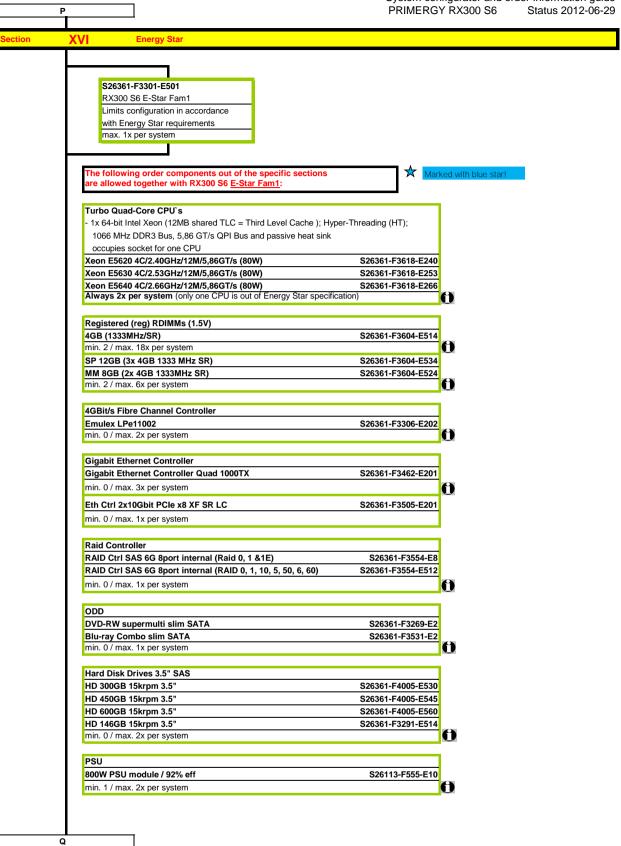


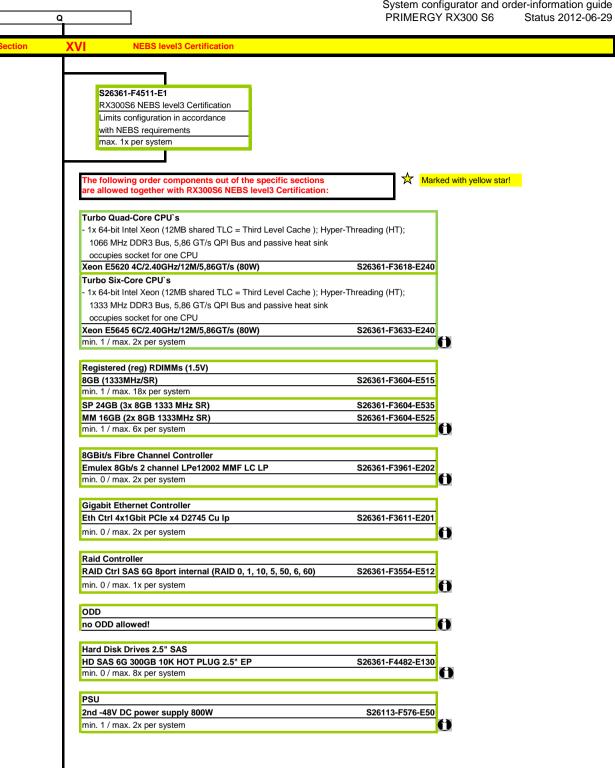




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End PRIMERGY RX300 S6

Change Report

| Date | Order number | Changes |
|------------|------------------------|--|
| | · | |
| 2012-01-30 | S26361-F3641-E2 | new Blue-ray Triple Writer added |
| 2011-12-21 | S26361-F4482-E114 | SAS HD 6G 144GB - no longer available |
| 2011-11-25 | S26361-F4492-E516 | New 16GB 2R 1333 memory module on status 35 |
| 2011-10-30 | S26361-F4541-Ex00 | new SAS SSD with 100, 200, 400 GB added - as soon as available |
| 2011-10-01 | S26361-F3601-E250 | new BC SATA HD - now available |
| 2011-10-01 | S26361-F3298-E64 | 64 GB SSD - no longer available |
| 2011-08-19 | S26361-F2735-E140/E82 | New RMK/Cablemanagement added |
| 2011-07-29 | S26361-F4482-E190 | new 6Gb SAS-HD 900GB - as soon as available |
| 2011-05-06 | S26361-F3604-E5x7 | 32GB DDR3 Qud Rank Modules added |
| 2011-05-03 | S26361-F3610-E202/L502 | Formal change from E201 / L501 |
| 2011-03-31 | S26361-F3629-E202 | 10 Gigabit Ethernet controller added |
| 2011-02-21 | | Corrected notched slots in configuration diagram |
| 2011-01-18 | S26361-F3648-E160 | Memory Speed for CPU L5609 corrected |
| 2011-01-10 | S26361-F3648-E160 | Westmere-EP Refresh CPUs added |
| 2010-11-18 | S26361-F3628-E201 | Ctrl SAS 6G 8port external added |
| 2010-11-16 | S26361-F4511-E1 | NEBS level3 certification restrictions implemented |
| 2010-11-16 | S26113-F576-E50/L50 | -48V DC power supply 800W added |
| 2010-11-16 | S26361-K1344-V801 | Carrier grade basic unit added, NEBS level3 certification possible |
| 2010-09-08 | 320301-1(1344-7001 | Additional hints for Spare / Performance / Mirrored Mode field upgrade |
| 2010-03-08 | S26361-F4482-Exxx | New HD SAS xxxGB 10k/15krpm 2.5" |
| 2010-07-09 | S26361-F3301-E501 | EPA Energy Star family certification restrictions implemented |
| 2010-07-03 | S26361-F3633-E240 | Additional CPU for RX300 S6 NEBS System (long delivery guarantied) |
| 2010-04-06 | S26361-F3601-E160/500 | new BC-SATA HD drives - now available |
| 2010-03-29 | S26361-F3257-E170 | BBU for Cougar and WaSat changed into F3257-E116 and E155 |
| 2010-03-01 | | First Release |
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